FEATURES

- For surface mounted applications
- Fast reverse recovery time
- Ideal for automated placement

MECHANICAL DATA

- Case: SOD-323W
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 5.48mg / 0.00019oz

PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode

Top View

Simplified outline SOD-323W and symbol

Absolute Maximum Ratings at 25 °C

Parameter	Symbols	1N4448WS	Units
Non-Repetitive Peak Reverse Voltage	V_{RM}	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Reverse Voltage	V_{RRM} V_{RWM} V_R	75	V
RMS Reverse Voltage	$V_{R(RMS)}$	53	V
Forward Continuous Current	I_{FM}	500	mA
Average Rectified Output Current	I_O	250	mA
Non-Repetitive Peak Forward Surge Current @t=1.0 μs @t=1.0 s	I_{FSM}	4.0 2.0	A
Power Dissipation	P_d	200	mW
Thermal Resistance Junction to Ambient Air	R_{thJA}	625	°C/W
Operating and Storage Temperature Rage	T_j, T_{stg}	-65 ~ +150	°C

Characteristics at T_a = 25 °C

Parameter		Symbols	1N4448WS	Units
Reverse BreakdownVoltage at I_R=1.0μA		$V_{(BR)R}$	75(min)	V
Forward Voltage	at 5 m A at 10 m A at 100 m A at 150 m A	V_F	0.62(min) 0.72(max) 0.855(max) 1.00(max) 1.25(max)	V
Peak Reverse Current	at V_R=75V at V_R=20V	I_R	2.5(max) 25(max)	μA nA
Typical Junction Capacitance	f=1MHz,V_R=0V	C_j	4(max)	pF
Maximum Reverse Recovery Time (1)		t_{rr}	4	ns

(1) Measured with I_F=I_R=10mA,Irr=0.1xI_R,R_L=100Ω

Fig.1 Power Derating Curve

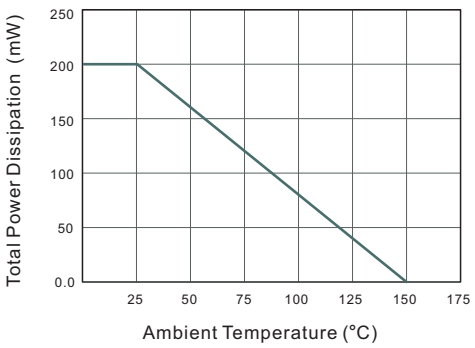


Fig.2 Typical Reverse Characteristics

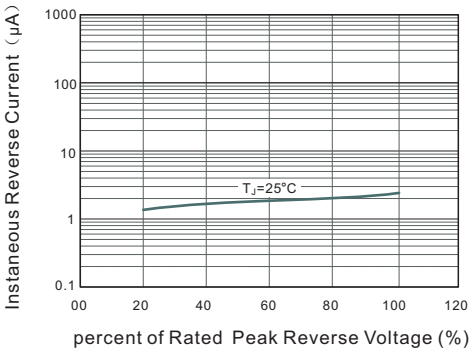


Fig.3 Typical Instaneous Forward Characteristics

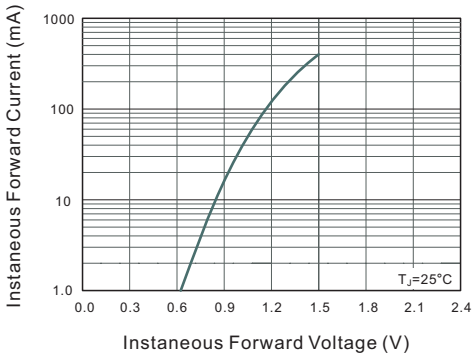
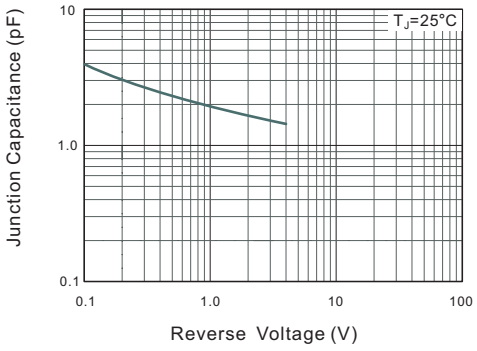


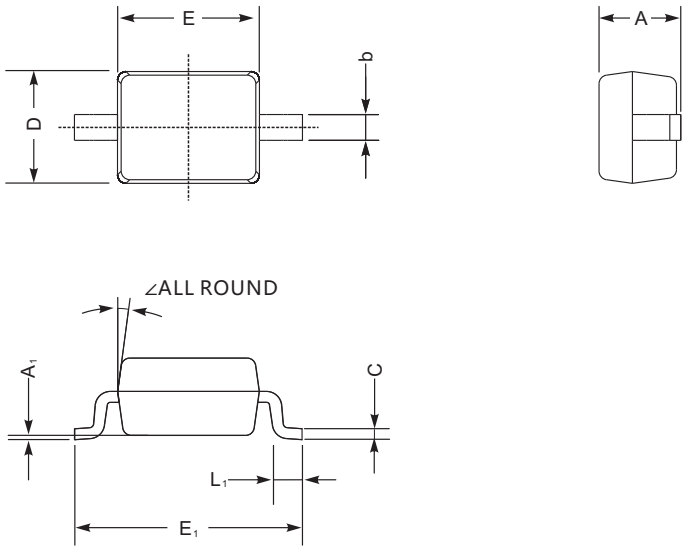
Fig.4 Typical Junction Capacitance



PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

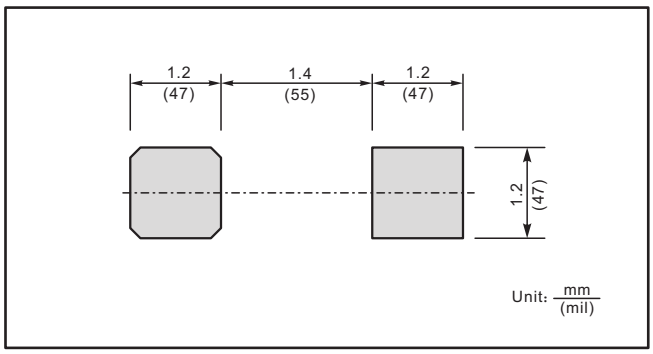
SOD-323W



SOD-323W mechanical data

UNIT		A	C	D	E	E_1	b	L_1	A_1	∠
mm	max	1.1	0.15	1.4	1.8	2.75	0.4	0.45	0.2	9°
	min	0.8	0.08	1.2	1.4	2.55	0.25	0.2	—	
mil	max	43	5.9	55	70	108	16	16	8	
	min	32	3.1	47	55	100	9.8	7.9	—	

The recommended mounting pad size



Marking

Type number	Marking code
1N4448WS	T5